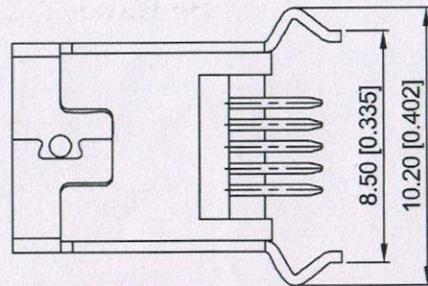


RECOMMENDED PCB LAYOUT



Material

Housing Material: LCP, UL94V-0, black
 Contact Terminal: Phosphor bronze, T=0.25mm
 Metallic Shell: Brass, T=0.4mm
 Plating

Contact Terminal

Underplating: Nickel all over
 Contact Plating: 1μ" gold
 Solder Tail: Bright Tin

Metallic Shell

Underplating: Nickel 50μ" all over
 Metallic Shell: Matte Tin 50μ" all over

Electrical

Voltage Rating: 30VDC
 Current Rating: 1A
 Contact Resistance: 50mΩ Max
 Insulation resistance: 100MΩ Min (Apply 100 VDC)
 Dielectric withstanding voltage: No discharge or flash (100V AC is applied for 1 minute)

Mechanical

Durability: 5,000 cycles
 Mating Force: 35N (3.57Kgf) Max
 Unmating Force: Initial - 7N (0.71Kgf) Min., 5001st cycle - 3N (0.31Kgf) Min.
 Environmental and Processing
 Operating Temperature: -50°C to +85°C

U215-05XN-4BP80

1: Au 1U"
 6: Au 30U"



DSND		DATE		SCALE: N/A	MODEL TYPE: MINI USB	
DWN		DATE		VIEW:	PART NO.:	
CHKD		DATE		UNIT: mm/in	DWG NO.:	
APPD		DATE		SIZE: A4	U215-05XN-4BP80	
				WEIGHT	SHEET	REVISION
				1.0g	1/1	A0

MARK	DESCRIPTION	DATE	REVISED	APPROVED	REVISIONS
ΔX					
ΔX					
ΔX					

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单击下面可查看定价，库存，交付和生命周期等信息

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